MMA709 2 Watt InGaP HBT Amplifier







3030 OUTLINE

SOIC8 OUTLINE

Description:

The MMA709-3030 is a Power InGaP HBT device that is designed to provide moderate power levels from 100 MHz to 2.5 GHz. Best operation is obtained across narrow bandwidths, typically 10%. The device is characterized in Class A operation. The device is assembled in a low profile plastic package that is a 3mm square DFN style that has eight leads. The backside of the packages are DC/RF/Thermal ground. The device is also available in SOIC8 Package.

Features:

High Output Power: +34 dBm (Typ)
High 3rd Order OIP3: +54 dBm (Typ)

High Dynamic Range: 97 dB (Typ)

· 3mm square DFN plastic package

RF Specifications:

Parameter	Cymbol	Condition	1960 MHz			2140 MHz			Units
raidilietei	Symbol	Condition	MIN	ТУР	MAX	MIN	ТУР	MAX	units
Gain	SSG	1, 2	10	11		9	9.5	13.5	dB
Output Power	P_{1dB}	1, 2	+33	+34		+33	+34		dBm
3 rd Order IP	OIP3	1, 2, 3	+52	+55		+50	+53		dBm
Input VSWR		1, 2			2:1			2:1	
Noise Figure	NF	1, 2		6.5	6.5		6.5	7.0	dB
Spur Free Dynamic Range	SFDR		95	102		95	102		dB
Thermal Resistance	Θ_{JC}	2						12	°C/W

NOTES:

- 1. All measurements from device evaluation boards.
- 2. $V_s = 7.00 \text{ V}, I_{cc} = 700 \text{ mA}.$
- 3. $\overline{\text{IP3}}$: Power output per tone = +15dBm, separation = 1.22 MHz

Absolute Maximum Ratings:

Parameters	Symbol	Minimum	Maximum	Unit
Operating temperature Range	T _{OP}	-40	+85	°C
Storage Temperature Range	T_{STOR}	-54	+125	°C
Breakdown Voltage, Collector to Emitter	BV_{CEO}	14.5		V
DC Collector Current	I _{cc}		900	mA
Operating Junction Temperature	$T_{\!\scriptscriptstyle J}$		150	°C

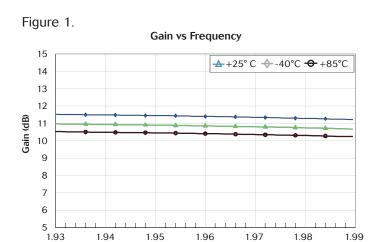
Contact the factory when using other than 7 volts.



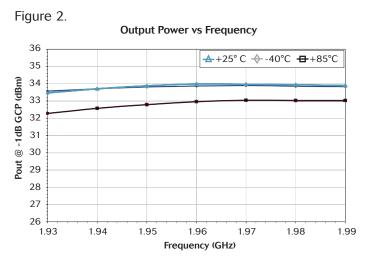


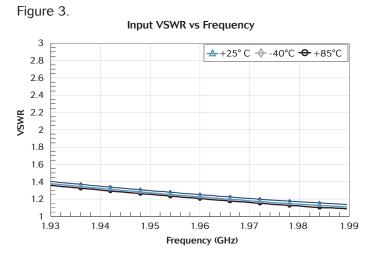
MMA709 2 Watt InGap HBT Amplifier

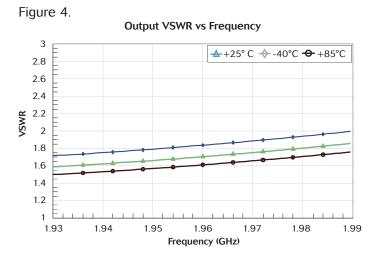
Typical PCS Band Performance, 3030 Package:

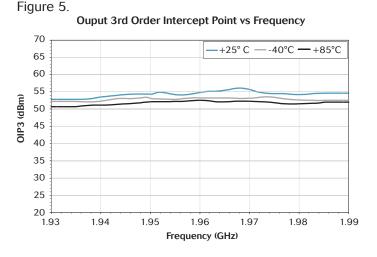


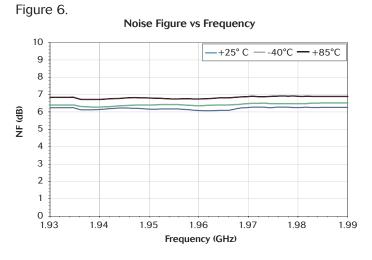
Frequency (GHz)







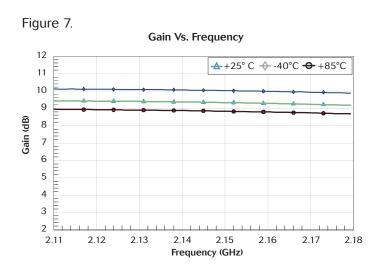


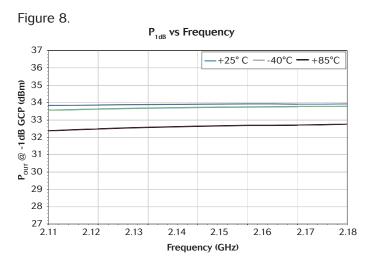


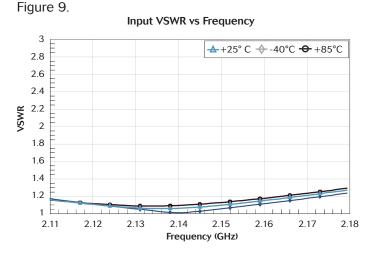
MMA709 2 Watt InGap HBT Amplifier

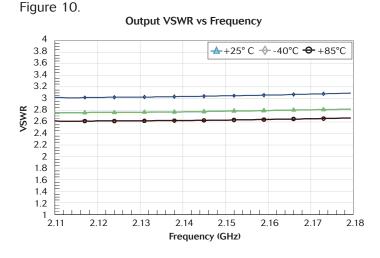


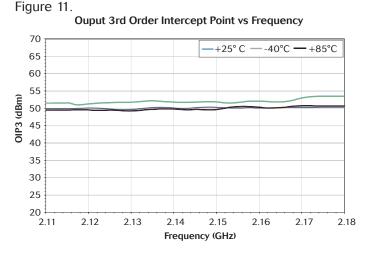
Typical UMTS Band Performance, 3030 Package:

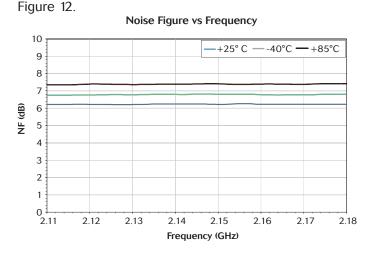










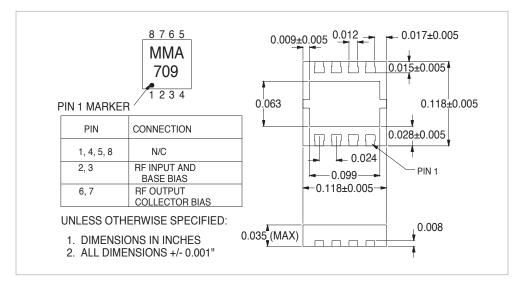




3030 Package Outline:

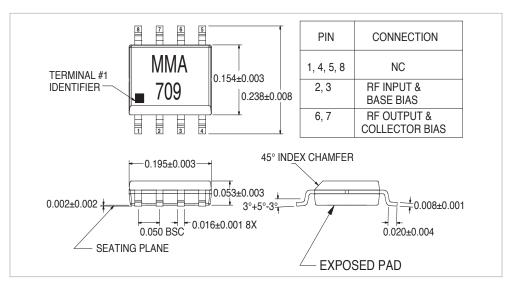
Figure 13.

MMA709 2 Watt InGaP HBT Amplifier



SOIC8 Package Outline:

Figure 14.



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